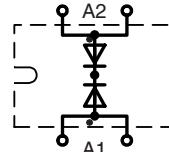


Power Schottky Rectifier

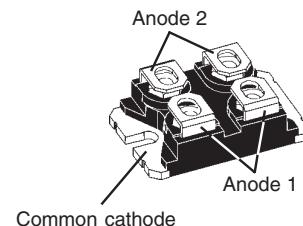
Non isolated

$I_{F_{AVM}} = 2 \times 160 \text{ A}$
 $V_{R_{RM}} = 100 \text{ V}$
 $V_F = 0.81 \text{ V}$

$V_{R_{SM}}$	$V_{R_{RM}}$	Type
V	V	
100	100	DSS 2x160-01A



miniBLOC, SOT-227 B



Symbol	Conditions	Maximum Ratings	
$I_{F_{RMS}}$		200	A
$I_{F_{AVM}}$	$T_C = 95^\circ\text{C}$; rectangular, $d = 0.5$	160	A
$I_{F_{AVM}}$	$T_C = 95^\circ\text{C}$; rectangular, $d = 0.5$; per device	320	A
$I_{F_{SM}}$	$T_{VJ} = 45^\circ\text{C}$; $t_p = 10 \text{ ms}$ (50 Hz), sine	1400	A
E_{AS}	$I_{AS} = 15 \text{ A}$; $L = 100 \mu\text{H}$; $T_{VJ} = 25^\circ\text{C}$; non repetitive	11.3	mJ
I_{AR}	$V_A = 1.5 \cdot V_{R_{RM}}$ typ.; $f=10 \text{ kHz}$; repetitive	1.5	A
$(dv/dt)_{cr}$		5000	V/ μ s
T_{VJ}		-40...+150	°C
T_{VJM}		150	°C
T_{stg}		-40...+150	°C
P_{tot}	$T_C = 25^\circ\text{C}$	410	W
M_d	mounting torque (M4) terminal connection torque (M4)	1.1-1.5/9-13 Nm/lb.in. 1.1-1.5/9-13 Nm/lb.in.	
Weight	typical	30	g

Symbol	Conditions	Characteristic Values	
		typ.	max.
I_R	① $V_R = V_{R_{RM}}$; $T_{VJ} = 25^\circ\text{C}$ $V_R = V_{R_{RM}}$; $T_{VJ} = 125^\circ\text{C}$	4 40	mA mA
V_F	$I_F = 160 \text{ A}$; $T_{VJ} = 125^\circ\text{C}$ $I_F = 160 \text{ A}$; $T_{VJ} = 25^\circ\text{C}$ $I_F = 320 \text{ A}$; $T_{VJ} = 125^\circ\text{C}$	0.81 0.98 1.08	V V V
R_{thJC} R_{thCH}		0.30 0.15	K/W K/W

Pulse test: ① Pulse Width = 5 ms, Duty Cycle < 2.0 %

Data according to IEC 60747 and per diode unless otherwise specified.

Features

- International standard package miniBLOC
- Epoxy meets UL 94V-0
- Very low V_F
- Extremely low switching losses
- Low I_{RM} -values

Applications

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters

Advantages

- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching
- Low losses

Dimensions see Outlines.pdf

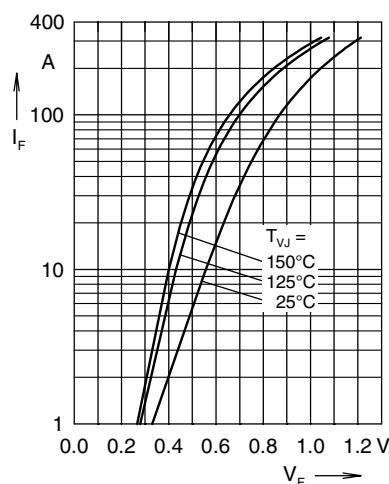


Fig. 1 Max. forward voltage drop characteristics

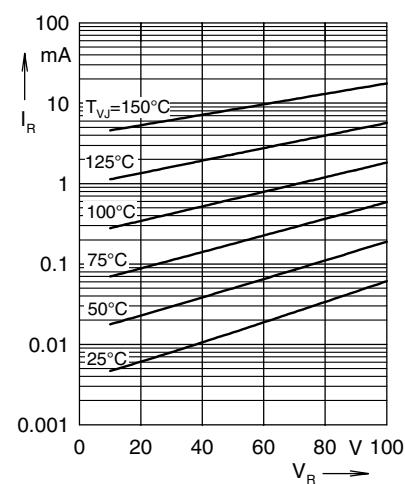
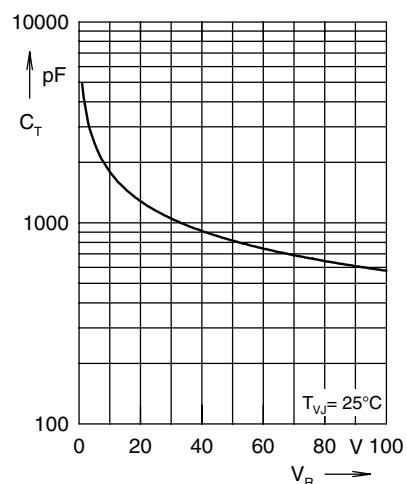
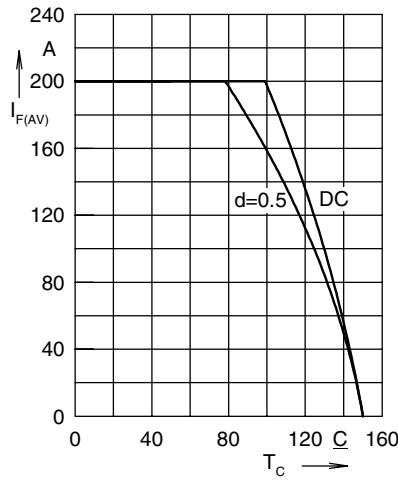
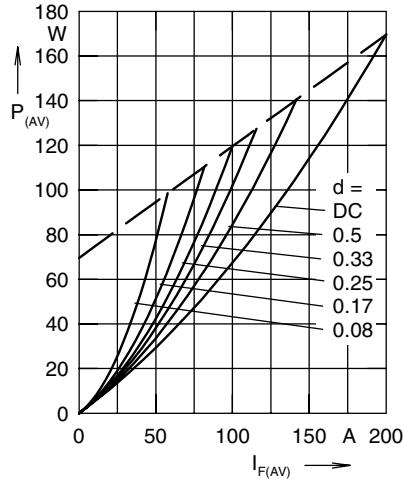
Fig. 2 Typ. reverse current I_R vs. reverse voltage V_R Fig. 3 Typ. junction capacitance C_T versus reverse voltage V_R Fig. 4 Avg. forward current $I_{F(AV)}$ vs. case temperature T_C 

Fig. 5 Forward power loss characteristics

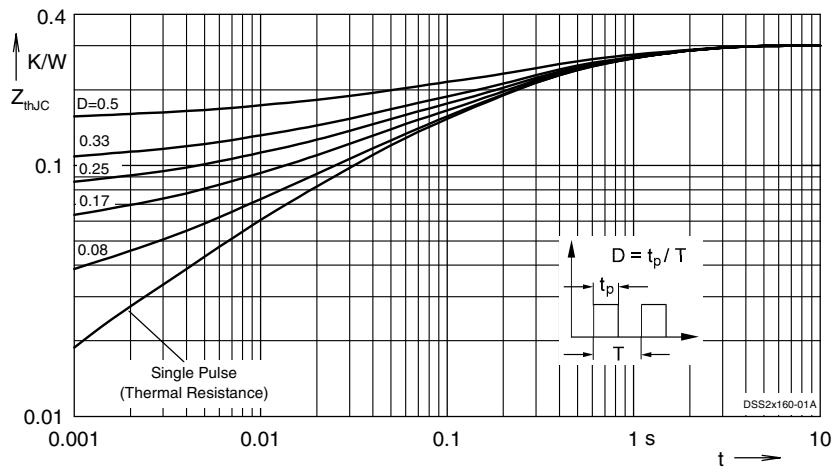


Fig. 6 Transient thermal impedance junction to case at various duty cycles

Note: All curves are per diode

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